Texas Instruments Company: **Company Texas Instruments** Name: **Nature Of** Semiconductor R&D **Business:** Designation **Embedded SW Engineer** Tentative Job Bangalore Location: As a Software/Firmware Engineer in the team, you will be working independently on development of platform software for the next generation automotive and radar device. Responsibilities include Understand Standard Specifications/ the functional specifications/ feature enhancements for the device accelerator or advanced peripheral subsystem and create detailed design documents and develop software and use-cases. Be an individual contributor in the software development domain - development & maintain products and support customers/field teams to integrate this functionality to end products What do we expect from you? Bachelor or Master's degree in Computer Science / Electrical / Electronic engineering. 0-2 years embedded software development experience Strong technical knowledge of embedded C, computer architecture, operating systems (RTOS). Strong C programming skills **Description:** Preferred Skills/ Experience Work experience in multi-core system preferred Good understanding of Development tools like GIT, JIRA, Confluence, Jenkins, TI Code Composer Studio Experienced with embedded software development and familiar with full software development cycle from definition through release to production **Experience in Embedded Linux development, Real Time Linux** Experience in Automotive functional safety development process Effective communication skills to interact with all stakeholders. Team and People Skills: The candidate should have good people skills to work closely with the systems, apps, marketing and test teams Must be highly focused and remain committed to obtaining closure on project goals Program AE BSBE CE CHE CSE EE ES ME MSE PHY CHM MTH ECO DES IME CGS HSS EEM MSP NET PSE Stats BT No No No No Yes Yes -- No No BS -- No --No No No No MT No No No No Yes Yes No No No No No No No Yes DoubleMajor No No No No Yes Yes -- No No No No No No dual No No No No Yes Yes No No No No No No No **Eligibilty:** dualB No No No No Yes Yes -- No No No No No No No No Yes dualC No No No No Yes Yes No No No No No No No No No Mdes Nο MBA No Phd No No No No No Yes No Yes No MSc -- ------ -- --No No No --No MSR No No No No Yes Yes -- No No Yes No B.tech: 21,50,880 Cost to **Company:** M.tech:24,48,905 B.tech: 21,50,880 Fixed: 14,00,000 Variable: 2,10,000 benefits: 1,15,880 Joining Bonus: 350,000 (paid in 2 installments, half immediately on joining and the rest half on completion of 1 **Package** M.tech:24,48,905 **Details:** Fixed: 15,25,000 Variable: 2,28,750 benefits: 1,20,155 Joining Bonus: 500,000 (paid in 2 installments, half immediately on joining and the rest half on completion of 1 year) Relocation assistance one time: 75,000 Bond: **False CPI CutOff:** 0.0Medical Requirments : Resume False **Shortlist: Aptitude** True

Test: **Aptitude 30** Test **Duration:** Group False **Discussion:** Technical True Test: Technical Test 45 min **Duration: Technical** True Interview: **Technical** 1 hour Interview **Duration:** Number of **Techincal** 2 Interview **Rounds:** HR True Interview:

HR Interview 15 min

Duration: Additional Information: